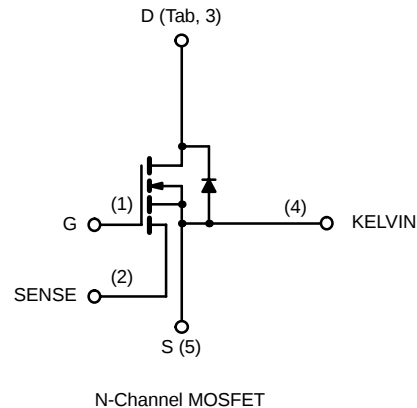
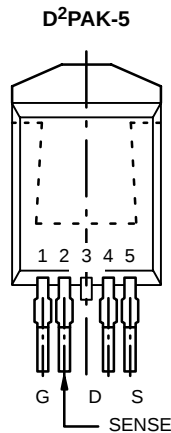




## Current Sensing MOSFET, N-Channel 30-V (D-S)

| PRODUCT SUMMARY   |                           |                 |
|-------------------|---------------------------|-----------------|
| $V_{(BR)DSS}$ (V) | $r_{DS(on)}$ ( $\Omega$ ) | $I_D$ (A)       |
| 30                | 0.015 @ $V_{GS} = 10$ V   | 50 <sup>a</sup> |
|                   | 0.02 @ $V_{GS} = 4.5$ V   | 48 <sup>a</sup> |

**175°C Rated**  
Maximum Junction Temperature  
**TrenchFET®**  
Power MOSFETs



| ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED) |                           |                |                  |                  |
|-----------------------------------------------------------------------------|---------------------------|----------------|------------------|------------------|
| Parameter                                                                   |                           | Symbol         | Limit            | Unit             |
| Drain-Source Voltage                                                        |                           | $V_{DS}$       | 30               | V                |
| Gate-Source Voltage                                                         |                           | $V_{GS}$       | $\pm 20$         |                  |
| Continuous Drain Current ( $T_J = 175^\circ\text{C}$ )                      | $T_C = 25^\circ\text{C}$  | $I_D$          | 50 <sup>a</sup>  | A                |
|                                                                             | $T_C = 125^\circ\text{C}$ |                | 32 <sup>a</sup>  |                  |
| Pulsed Drain Current                                                        |                           | $I_{DM}$       | 100              |                  |
| Avalanche Current                                                           |                           | $I_{AR}$       | 25               |                  |
| Repetitive Avalanche Energy <sup>b</sup>                                    |                           | $E_{AR}$       | 31               | mJ               |
| Maximum Power Dissipation <sup>b</sup>                                      | $T_C = 25^\circ\text{C}$  | $P_D$          | 83 <sup>c</sup>  | W                |
|                                                                             | $T_A = 25^\circ\text{C}$  |                | 2.7 <sup>d</sup> |                  |
| Operating Junction and Storage Temperature Range                            |                           | $T_J, T_{stg}$ | -55 to 175       | $^\circ\text{C}$ |

| THERMAL RESISTANCE RATINGS |                        |            |       |                    |
|----------------------------|------------------------|------------|-------|--------------------|
| Parameter                  |                        | Symbol     | Limit | Unit               |
| Junction-to-Ambient        | PCB Mount <sup>d</sup> | $R_{thJA}$ | 55    | $^\circ\text{C/W}$ |
| Junction-to-Case           |                        | $R_{thJC}$ | 1.8   |                    |

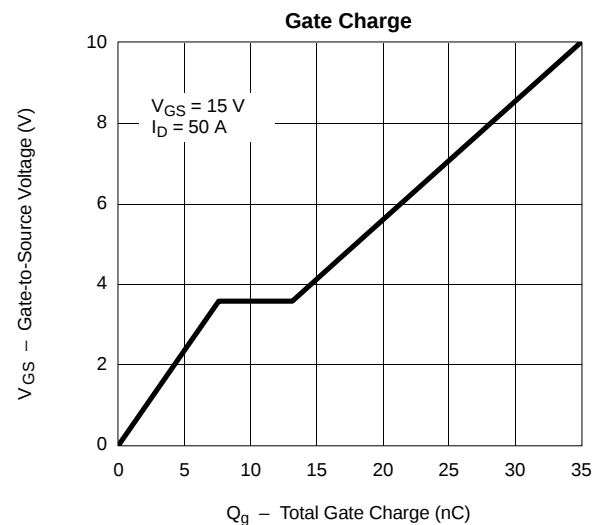
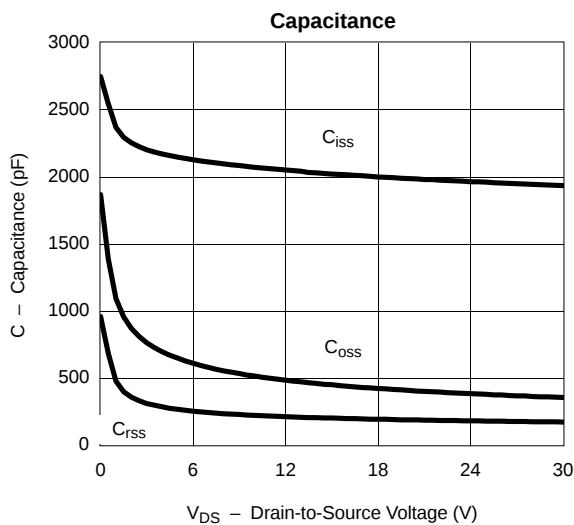
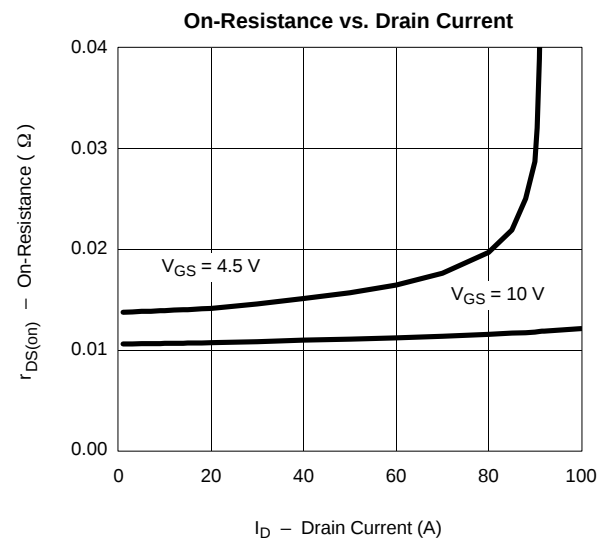
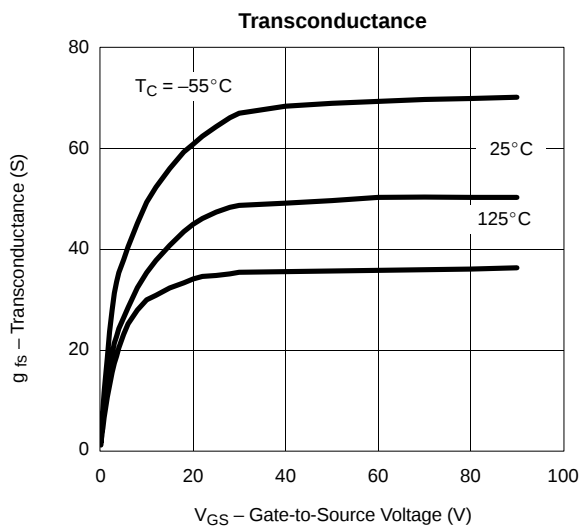
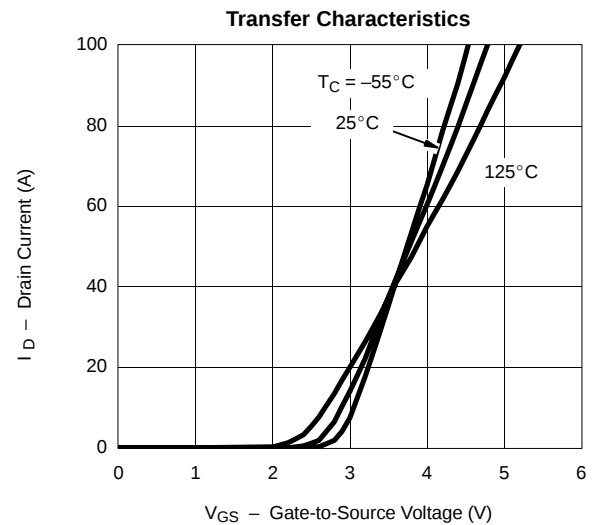
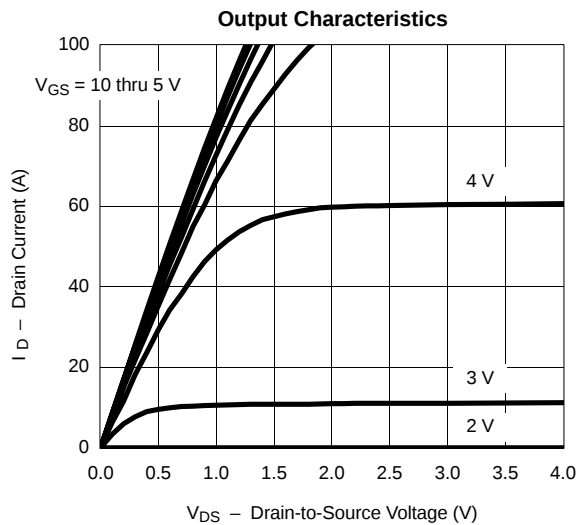
## Notes

- Package limited.
- Duty cycle  $\leq 1\%$ .
- See SOA curve for voltage derating.
- When mounted on 1" square PCB (FR-4 material).

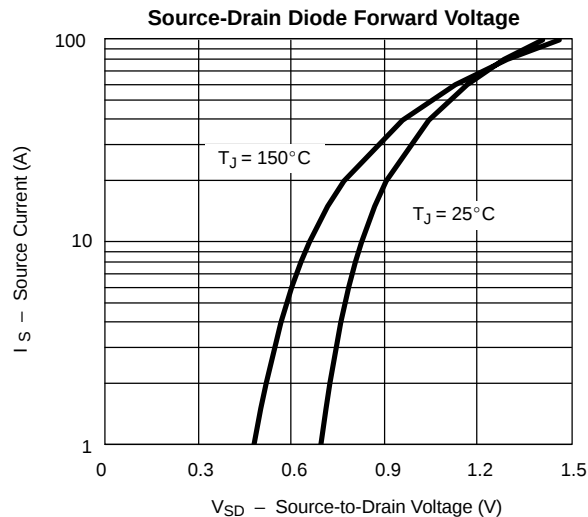
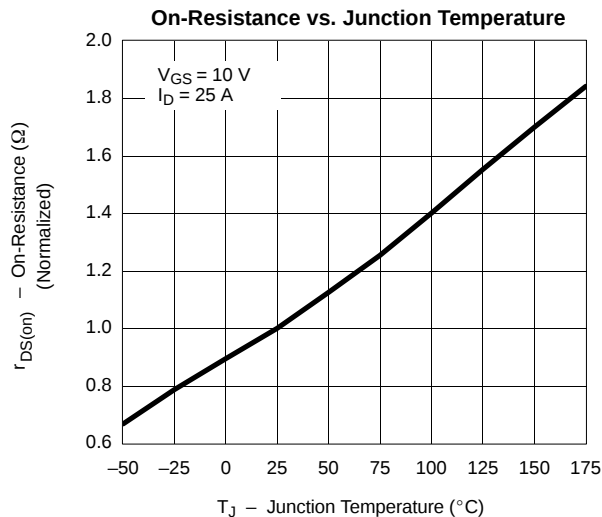
| MOSFET SPECIFICATIONS (T <sub>J</sub> =25° C UNLESS OTHERWISE NOTED)                 |                      |                                                                                                                          |     |       |       |      |
|--------------------------------------------------------------------------------------|----------------------|--------------------------------------------------------------------------------------------------------------------------|-----|-------|-------|------|
| Parameter                                                                            | Symbol               | Test Condition                                                                                                           | Min | Typ   | Max   | Unit |
| Static                                                                               |                      |                                                                                                                          |     |       |       |      |
| Drain-Source Breakdown Voltage                                                       | V <sub>(BR)DSS</sub> | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA                                                                           | 30  |       |       | V    |
| Gate Threshold Voltage                                                               | V <sub>GS(th)</sub>  | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>DS</sub> = 250 μA                                                             | 1   |       | 3     |      |
| Gate-Body Leakage                                                                    | I <sub>GSS</sub>     | V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 20 V                                                                          |     |       | ± 100 | nA   |
| Zero Gate Voltage Drain Current                                                      | I <sub>DSS</sub>     | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V                                                                            |     |       | 1     | μA   |
|                                                                                      |                      | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125° C                                                   |     |       | 50    |      |
|                                                                                      |                      | V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175° C                                                   |     |       | 150   |      |
| On-State Drain Current <sup>a</sup>                                                  | I <sub>D(on)</sub>   | V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V                                                                            | 50  |       |       | A    |
| Drain-Source On-State Resistance <sup>a</sup>                                        | r <sub>DS(on)</sub>  | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 25 A                                                                            |     | 0.012 | 0.015 | Ω    |
|                                                                                      |                      | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 25 A, T <sub>J</sub> = 125° C                                                   |     | 0.019 | 0.024 |      |
|                                                                                      |                      | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 25 A, T <sub>J</sub> = 175° C                                                   |     | 0.022 | 0.027 |      |
|                                                                                      |                      | V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 24 A                                                                           |     | 0.016 | 0.02  |      |
| Forward Transconductance <sup>a</sup>                                                | g <sub>fs</sub>      | V <sub>DS</sub> = 15 V, I <sub>D</sub> = 25 A                                                                            | 30  |       |       | S    |
| Dynamic <sup>b</sup>                                                                 |                      |                                                                                                                          |     |       |       |      |
| Input Capacitance                                                                    | C <sub>iss</sub>     | V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, f = 1 MHz                                                                 |     | 1960  |       | pF   |
| Output Capacitance                                                                   | C <sub>oss</sub>     |                                                                                                                          |     | 380   |       |      |
| Reversen Transfer Capacitance                                                        | C <sub>rSS</sub>     |                                                                                                                          |     | 180   |       |      |
| Total Gate Charge <sup>c</sup>                                                       | Q <sub>g</sub>       | V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 20 V, I <sub>D</sub> = 50 A                                                    |     | 35    | 50    | nC   |
| Gate-Source Charge <sup>c</sup>                                                      | Q <sub>gs</sub>      |                                                                                                                          |     | 7.6   |       |      |
| Gate-Drain Charge <sup>c</sup>                                                       | Q <sub>gd</sub>      |                                                                                                                          |     | 5.6   |       |      |
| Turn-On Delay Time <sup>c</sup>                                                      | t <sub>d(on)</sub>   | V <sub>DD</sub> = 15 V, R <sub>L</sub> = 0.3 Ω<br>I <sub>D</sub> ≈ 50 A, V <sub>GEN</sub> = 10 V, R <sub>G</sub> = 2.5 Ω |     | 10    | 20    | ns   |
| Rise Time <sup>c</sup>                                                               | t <sub>r</sub>       |                                                                                                                          |     | 93    | 180   |      |
| Turn-Off Delay Time <sup>c</sup>                                                     | t <sub>d(off)</sub>  |                                                                                                                          |     | 30    | 60    |      |
| Fall Time <sup>c</sup>                                                               | t <sub>f</sub>       |                                                                                                                          |     | 10    | 20    |      |
| Source-Drain Diode Ratings and Characteristics (T <sub>C</sub> = 25° C) <sup>b</sup> |                      |                                                                                                                          |     |       |       |      |
| Continuous Current                                                                   | I <sub>s</sub>       |                                                                                                                          |     |       | 50    | A    |
| Pulsed Current                                                                       | I <sub>SM</sub>      |                                                                                                                          |     |       | 100   |      |
| Forward Voltage <sup>a</sup>                                                         | V <sub>SD</sub>      | I <sub>F</sub> = 50 A, V <sub>GS</sub> = 0 V                                                                             |     | 1.3   | 1.6   | V    |
| Reverse Recovery Time                                                                | t <sub>rr</sub>      | I <sub>F</sub> = 50 A, di/dt = 100 A/μs                                                                                  |     | 35    | 70    | ns   |
| Peak Reverse Recovery Current                                                        | I <sub>RM(REC)</sub> |                                                                                                                          |     | 1.5   |       | A    |
| Reverse Recovery Charge                                                              | Q <sub>rr</sub>      |                                                                                                                          |     | 0.026 |       | μC   |
| Current Sense Characteristics                                                        |                      |                                                                                                                          |     |       |       |      |
| Current Sensing Ratio                                                                | r                    | I <sub>D</sub> = 1 A, V <sub>GSS</sub> = 10 V, R <sub>SENSE</sub> = 2.2 Ω                                                | 420 | 520   | 620   |      |
| Mirror Active Resistance                                                             | r <sub>m(on)</sub>   | V <sub>GS</sub> = 10 V, I <sub>D</sub> = 10 mA                                                                           |     | 3.5   |       | Ω    |

Notes:

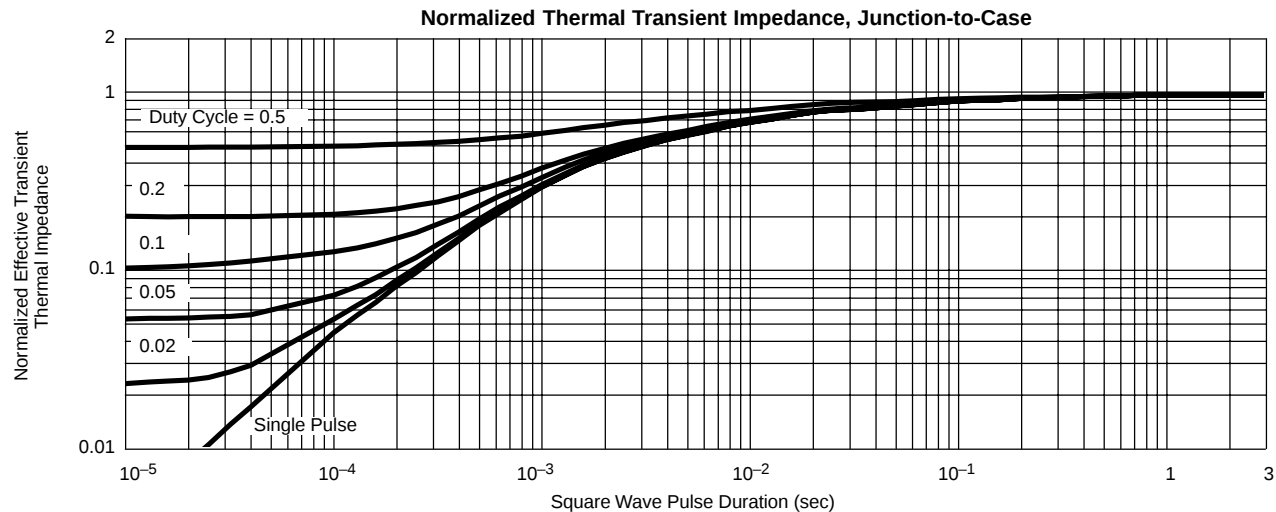
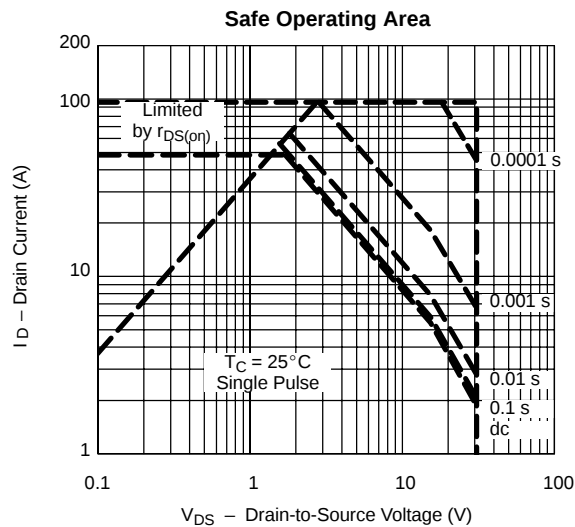
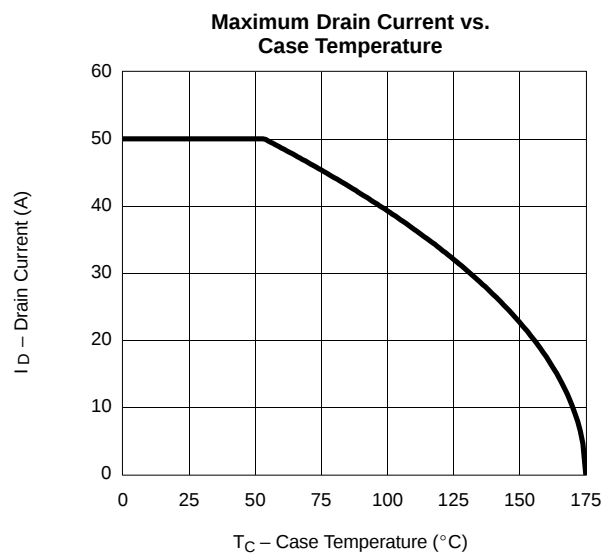
- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2%.  
e. Guaranteed by design, not subject to production testing.  
b. Independent of operating temperature.

**TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)**

## TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



## THERMAL RATINGS



### TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

### SENSE DIE

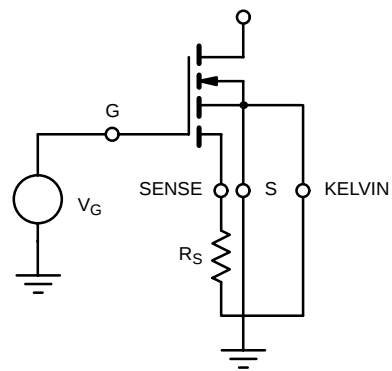
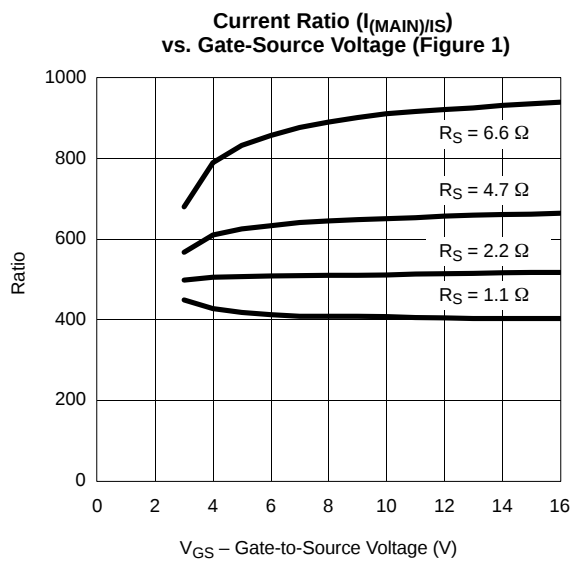
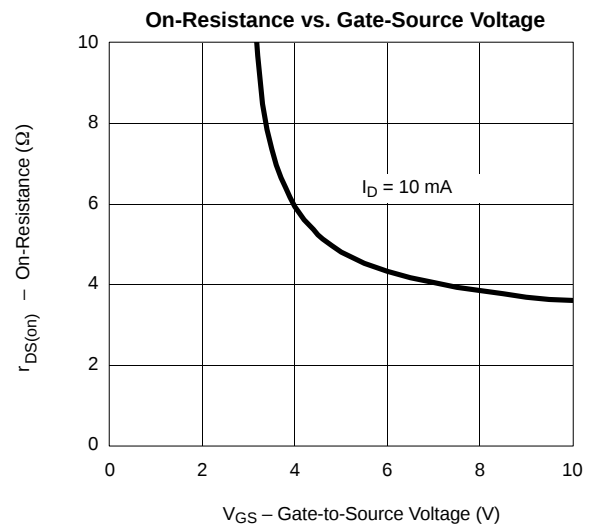
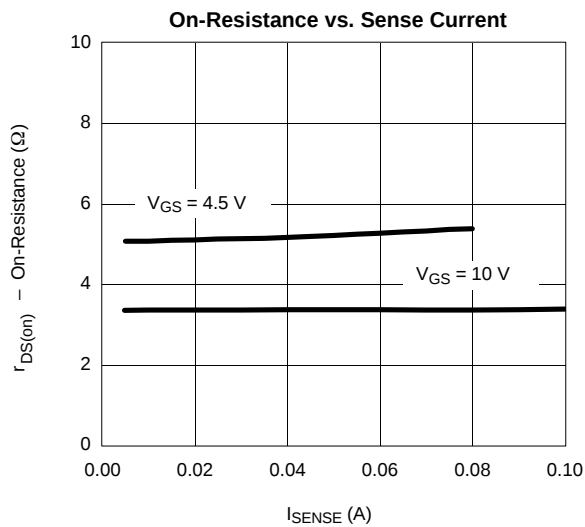


Figure 1